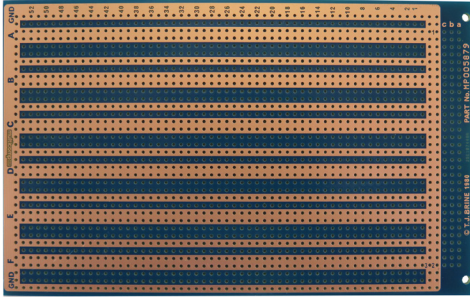


High Density Prototyping Eurocard Circuit Board

multicomp PRO

**RoHS
Compliant**



Description

This series of High-Density prototyping Eurocard circuit boards. Its high-speed point to point, hand wiring, rapid wiring method of Dual In Line (DIL) Integrated Circuits and early Micoprocessors. Additionally, these versatile boards are equally suitable for a wide range of uses, including wire-wrap or other high-density general-purpose prototyping applications.

Features

- A3 plane prototyping board with a copper pattern screen or ground plane marked 'GND' on the component side. The wiring side pattern has two power rails marked 'VCC' and 'GND' and the screen may be connected to the 'GND' rail by pinning
- Hole matrix 2.54mm x 2.54mm
- DIN 41612 connector mounting holes at one end – 32/64/96 way
- Used with wire wrapping or discrete component wiring
- Grid references
- Material epoxy glass or FR4
- Board thickness 1.6mm
- Hole size 1.02mm
- Copper Thickness 1 oz/ft² or 35 microns or 305g/m²
- Protective Coating OSP - organic solderability preservatives (anti tarnish)

Part Number Table

| Description | Part Number |
|--|-------------|
| Single height, Double Sided Eurocard 3 plane, 3U – 100mm×160mm | MP005879 |

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